

X2-Class **Power MOSFET**

IXTK102N65X2 IXTX102N65X2

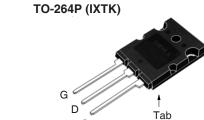
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

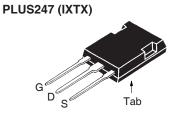


Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}$ $T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	650 650	V	
V _{DGR}				
V _{GSS}	Continuous	± 30	V	
V _{GSM}	Transient	± 40	V	
I _{D25}	T _C = 25°C	102	А	
I _{DM}	T_{c}° = 25°C, Pulse Width Limited by T_{JM}	204	Α	
I _A	T _C = 25°C	25	Α	
I _A E _{AS}	$T_{c} = 25^{\circ}C$	3	J	
P_{D}	T _C = 25°C	1040	W	
dv/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	50	V/ns	
T _J		-55 +150	°C	
T _{.IM}		150	°C	
T _{stg}		-55 +150	°C	
T,	Maximum Lead Temperature for Soldering	300	°C	
T _{SOLD}	Plastic Body for 10s	260	°C	
M _d	Mounting Torque (TO-264P)	1.13/10	Nm/lb.in	
F_c	Mounting Force (PLUS247)	20120 /4.527	N/lb	
Weight	TO-264P	10	g	
	PLUS247	6	g	

			cteristic Typ.	Values Max		
BV _{DSS}	$V_{GS} = 0V, I_{D} = 1mA$		650			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250\mu A$		3.0		5.0	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$				± 100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$	T _J = 125°C			25 350	μ Α μ Α
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \cdot I_{D25}, No.$	te 1			30	mΩ

650V 102A D25 $30m\Omega$ $\mathbf{R}_{\mathrm{DS(on)}}$





G = Gate	D = Drain
S = Source	Tab = Drain

Features

- International Standard Packages
- Low Q_G
 Avalanche Rated
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls



		acteristic Typ.	Values Max	
g _{fs}	$V_{DS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$	50	82	S
R _{Gi}	Gate Input Resistance		0.7	Ω
C _{iss}			10.9	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		6100	pF
C _{rss}			12.6	pF
	Effective Output Capacitance			
$C_{o(er)}$	Energy related $\bigvee_{GS} = 0V$		367	pF
$\mathbf{C}_{o(tr)}$	Time related $\int V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		1420	pF
t _{d(on)}	Resistive Switching Times		37	ns
t,	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		28	ns
t _{d(off)}	$R_{G} = 2\Omega$ (External)		67	ns
t _f			11	ns
Q _{g(on)}			152	nC
Q _{gs}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		57	nC
Q _{gd}			33	nC
R _{thJC}				0.12 °C/W
R _{thCS}			0.15	°C/W

Source-Drain Diode

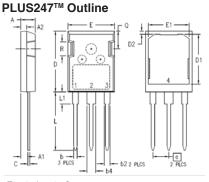
Symbo	l Test Conditions	Characteristic Values			
$(T_{J} = 25)$	5°C, Unless Otherwise Specified)	Min.	Тур.	Max.	
Is	$V_{GS} = 0V$			102	Α
I _{sm}	Repetitive, Pulse Width Limited by $T_{_{JM}}$			408	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.4	V
t _{rr}	$I_{\rm E} = 51A$, -di/dt = 100A/ μ s		450		ns
$\mathbf{Q}_{_{\mathrm{RM}}}$	} '		11.7		μC
I _{RM}	$V_{R} = 100V, V_{GS} = 0V$		52		Α

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

TO-264P Outline Q1 x2e INCHES **MILLIMETERS** SYM MIN MAX 4.70 5.30 MIN MA> .185 Α1 102 0.90 .049 ь b1 .035 2.30 2.80 .091 106 .126 .033 b2 110 0.50 25.70 19.90 .020 1.035 .799 \Box 1.012 D 1 D2 4.70 19.70 16.80 17. .661 .677 5.46 768 .807 .106 .091 5.80 8.80 3.80 228 346 .244 .362 Q Q1 .165 ØR



.087

1.80

Terminals: 1 - Gate 2,4 - Drain 3 - Source

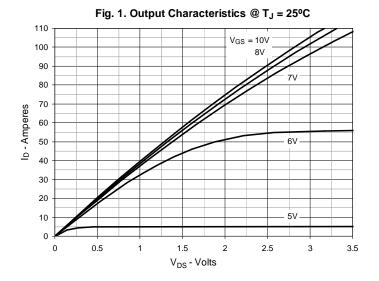
ØR1

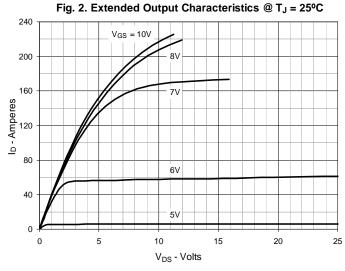
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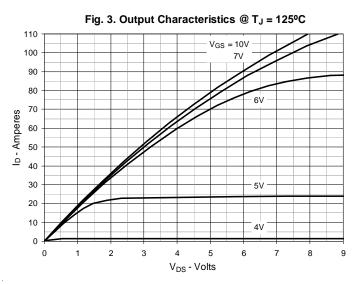
SYM INCHES		MILLIN	METERS	
SIM	MIN	MAX	MIN	MAX
Α	.190	.205	4.83	5.21
A1	.090	.100	2.29	2,54
A2	.075	.085	1.91	2.16
Ь	.045	.055	1.14	1.40
b2	.075	.087	1.91	2,20
b4	.115	.126	2.92	3.20
С	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
D1	.650	.690	16.51	17.53
D2	.035	.050	0.89	1.27
E	.620	.635	15.75	16.13
E1	.520	.560	13.08	14.22
е	.215 BSC		5.45 BSC	
L	.780	.810	19.81	20.57
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83

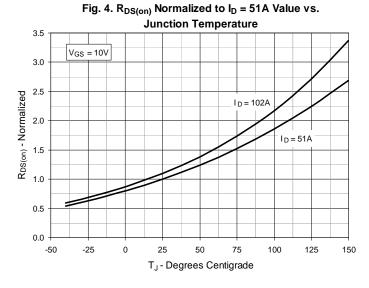
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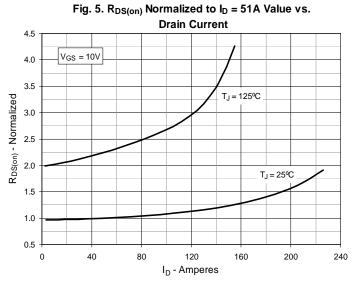


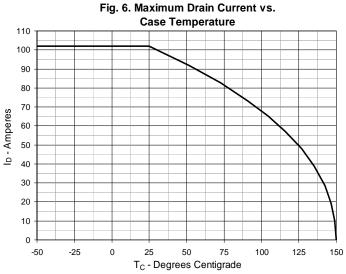




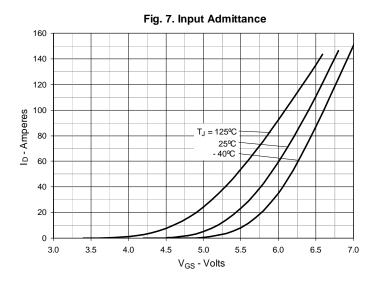


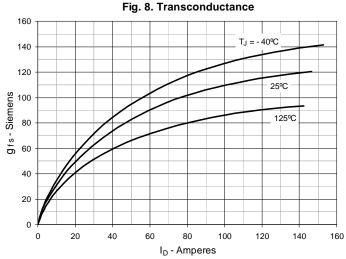


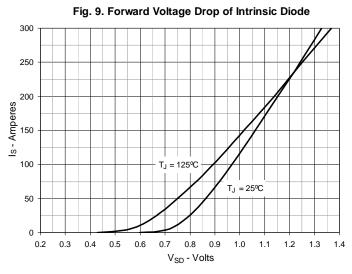


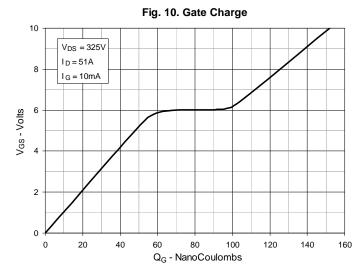


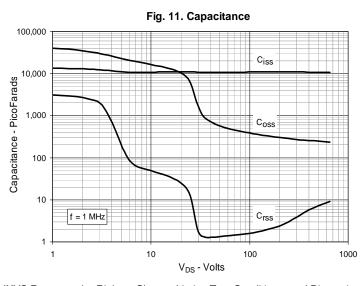


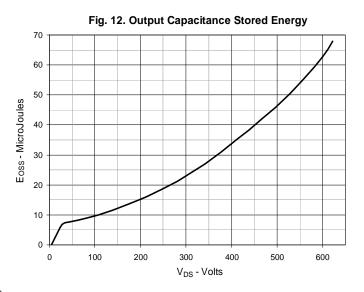












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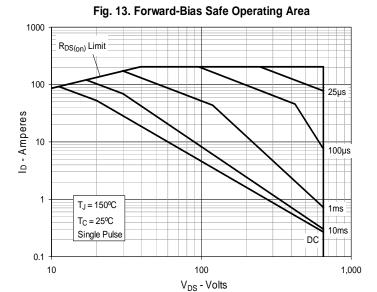


Fig. 14. Maximum Transient Thermal Impedance

Pulse Width - Seconds

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